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To All Proposers:

Subject: Bid #: 8397-W5, Chip Sealing – Various Streets / DPWP

ADDENDUM NO. 1

To Whom It May Concern:

With reference to our proposal request relative to the above subject, please refer to the changes/modifications/clarifications to the original proposal request.

 PRE-BID MEETING TO BE HELD on 4/9/25 at 11:00 am AT THE DPWP 2ND FLOOR CONFERENCE ROOM, 20 E. WORCESTER STREET

Bidders are requested to acknowledge and/or include this addendum with submission. All other terms, conditions and specifications remain unchanged.

Very truly yours

Christopher J. Gagliastro Purchasing Director